

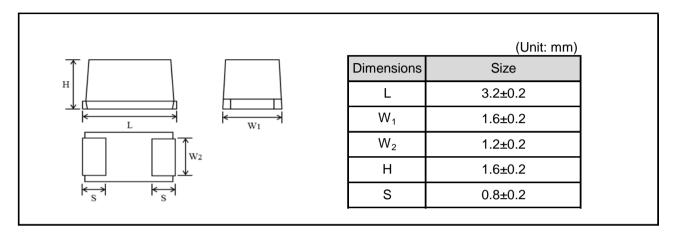
# Conductive polymer chip capacitors (Bottom surface electrode type : Large capacitance)

TCTO series A case Datasheet

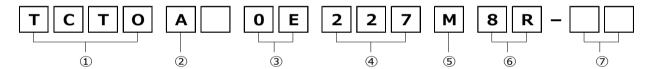
#### Features

- 1) Conductive polymer used at the cathode for ultra-low ESR.
- 2) Bottom electrode configuration results in the largest capacitance.
- 3) Compact, low profile, high capacitance contribute to smaller, thinner sets with greater functionality.
- 4) Conductive polymer has a self-healing function that prevents failure, resulting in safe, high reliability operation.

### Dimensions



# Part No. Explanation



① Series name TCTO

2 Case style

A: 3216-3216(18)size

3 Rated voltage

Rated voltage(V)
2.5
4
6.3
10
16
20
25
35
50

4 Nominal capacitance

Nominal capacitance in pF in 3 digits: 2 significant figures followed by the figure representing the number of 0's.

**5** Capacitance tolerance

M: ±20%

6 Taping

8: Tape width

R: Positive electrode on the side opposite to sprocket hole

7 Discrimination code

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## Rated table

 $ESR(m\Omega)$ 

									LO1 ((11132)
Capaci		Rated voltage (V.DC)							
(µF	=)	2.5	4	6.3	10	16	20	25	35
4.7	(475)								
6.8	(685)								
10	(106)							☆200	
15	(156)								
22	(226)					200			
33	(336)								
47	(476)				200				
68	(686)								
100	(107)			<b>☆</b> 35/45					
150	(157)			<b>☆</b> 35/200					
220	(227)	35							·
330	(337)	<b>☆</b> 35/ <b>☆</b> 200							
470	(477)		_		•		•		·

☆Under development

# Marking

The indications listed below should be given on the surface of a capacitor.

- (1) Polarity: The polarity should be shown by bar. (on the anode side)
- (2) Rated DC voltage: A voltage code is shown as below table.
- (3) Capacitance: A capacitance code is shown as below table.

Voltage Code	Rated DC
voltage Code	Voltage (V)
е	2.5
g	4
j	6.3
k	8
Α	10
С	16
D	20
E	25
V	35
Н	50

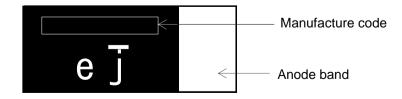
Capacitance	Nominal	Capacitance	Nominal
Code	Capacitance (µF)	Code	Capacitance (µF)
<u>E</u>	0.15	е	15
<u>N</u>	0.33	j	22
<u>S</u>	0.47	n	33
Α	1.0	s	47
E	1.5	w	68
J	2.2	а	100
N	3.3	е	150
S	4.7	<del>j</del>	220
W	6.8	n	330
а	10	s	470

Visual typical example

voltage code and capacitance code are variable with parts number.

[TCTO series A case]

- (1) voltage code
- (2) capacitance code



**TCTO** series A case Datasheet

# Characteristics

Item		Performance	Test conditions (based on JIS C 5101-1 and JIS C 5101-3)				
Operating Tempo	erature	-55℃~+105℃	Voltage reduction when temperature exceeds +85°C				
Maximum operat	ing	+85℃					
temperature with	no						
voltage derating							
Rated voltage (V	'.DC)	Refer to " Standard list ".	at 85℃				
Category voltage	e (V.DC)	Refer to " Standard list ".	at 105℃				
Surge voltage (V	tage (V.DC) Refer to " Standard list ". at 85℃						
DC Leakage cur	rent	Shall be satisfied the value on	As per 4.9 JIS C 5101-1				
		" Standard list ".	As per 4.5.1 JIS C 5101-3				
			Voltage: Rated voltage for 5min				
Capacitance tole	erance	Shall be satisfied allowance range.	As per 4.7 JIS C 5101-1				
		±20%	As per 4.5.2 JIS C 5101-3				
			Measuring frequency: 120 ± 12Hz				
			Measuring voltage: 0.5Vrms + 1.5V.DC				
Tongont of loop	an ala	Shall be satisfied the value on	Measuring circuit : DC Equivalent series circuit As per 4.8 JIS C 5101-1				
Tangent of loss a (Df,tanδ)	angle	" Standard list ".	As per 4.5.3 JIS C 5101-3				
(Di,tailo)		Standard list .	Measuring frequency : 120 ± 12Hz				
			Measuring voltage: 0.5Vrms + 1.5V.DC				
			Measuring circuit : DC Equivalent series circuit				
ESR		Shall be satisfied the value on	As per 4.10 JIS C 5101-1				
		" Standard list ".	As per 4.5.4 JIS C 5101-3				
			Measuring frequency: 100 ± 10kHz				
			Measuring voltage: 0.5Vrms or less				
			Measuring circuit : DC Equivalent series circuit				
Resistance to	Appe-	There should be no significant	As per 4.14 JIS C 5101-1				
Soldering	arance	abnormality.	As per 4.6 JIS C 5101-3				
heat		The indications should be clear.	Dip in the solder bath				
	L.C.	Less than 300% of initial limit.	Solder temp : 240 ± 5°C				
	⊿C/C	Within ±20% of initial value.	Duration: 10 ± 0.5s				
	20/0	Within ±20% of initial value.	Repetition: 1 After the specimens, leave it at room temperature				
	DF	Less than 300% of initial limit.	for over 24h and then measure the sample.				
	(tanδ)	Loss than 500 % of milital limit.	for over 2411 and then measure the sample.				
Temperature	Appe-	There should be no significant	As per 4.16 JIS C 5101-1				
cycle	arance	abnormality.	As per 4.10 JIS C 5101-3				
-		The indications should be clear.	Repetition : 5 cycles				
	L.C.	Less than 1000% of initial limit.	(1 cycle : steps 1 to 4) without discontinuation.				
	⊿C/C	Within ±20% of initial value.	Temp. Time				
			1 -55±3°C 30±3min				
	DF	Less than 300% of initial limit.	2 Room Temp. 3min or less				
	(tanδ)		3 105±2℃ 30±3min				
	1		4 Room Temp. 3min or less				
			After the specimens, leave it at room temperature				



**TCTO** series A case

Stability  □C  Dif (tan L.C  Temp □C  Dif (tan L.C  Surge  App	abnormality. The indications should be clear.  Less than 300% of initial limit.  Within +30/-20% of initial value.  Less than 300% of initial limit.  Less than 300% of initial value.  Shall be satisfied the value on "Standard list"  Shall be satisfied the value.  Shall be satisfied the value.  Shall be satisfied the value on Shall be satisfied the value.	(based on JIS C 5101-1 and JIS C 5101-3)  As per 4.22 JIS C 5101-1  As per 4.12 JIS C 5101-3  After leaving the sample under such atmospheric condition that the temperature and humidity are 40±2°C and 90 to 95% RH, respectively, for 500+12/0h leave it at room temperature for over 24h and then measure the sample.  As per 4.29 JIS C 5101-1  As per 4.13 JIS C 5101-3
L.C  □ DF (tan  Temperature Stability □ DF (tan  L.C  Temp □ □ C  Temp □ □ C  Surge voltage □ App arar	The indications should be clear.  Less than 300% of initial limit.  C Within +30/-20% of initial value.  Less than 300% of initial limit.  5)  : -55°C  C Within 0/-20% of initial value.  Shall be satisfied the value on "Standard list"  : +105°C  C Within +50/0% of initial value.  Shall be satisfied the value on	After leaving the sample under such atmospheric condition that the temperature and humidity are 40±2°C and 90 to 95% RH, respectively, for 500+12/0h leave it at room temperature for over 24h and then measure the sample.  As per 4.29 JIS C 5101-1
□ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □	Less than 300% of initial limit.  C Within +30/-20% of initial value.  Less than 300% of initial limit.  5)  : -55°C  C Within 0/-20% of initial value.  Shall be satisfied the value on "Standard list"  : +105°C  C Within +50/0% of initial value.  Shall be satisfied the value on	condition that the temperature and humidity are 40±2°C and 90 to 95% RH, respectively, for 500+12/0h leave it at room temperature for over 24h and then measure the sample.  As per 4.29 JIS C 5101-1
□ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □	C Within +30/-20% of initial value.  Less than 300% of initial limit.  5)  : -55°C  C Within 0/-20% of initial value.  Shall be satisfied the value on  " Standard list "   .: +105°C  C Within +50/0% of initial value.  Shall be satisfied the value on	40±2°C and 90 to 95% RH, respectively, for 500+12/0h leave it at room temperature for over 24h and then measure the sample.  As per 4.29 JIS C 5101-1
Dif (tan) Temperature Stability  □ Dif (tan) □ L.C  Temp □ △ C  □ Dif (tan) □ L.C  Surge Voltage  □ App □ arar	Less than 300% of initial limit.  5)  Less than 300% of initial limit.  C Within 0/-20% of initial value.  Shall be satisfied the value on  "Standard list"  -  L: +105°C  Within +50/0% of initial value.  Shall be satisfied the value on	500+12/0h leave it at room temperature for over 24h and then measure the sample.  As per 4.29 JIS C 5101-1
Dif (tan) Temperature Stability  □ Dif (tan) □ L.C  Temp □ △ C  □ Dif (tan) □ L.C  Surge Voltage  □ App □ arar	Less than 300% of initial limit.  5)  Less than 300% of initial limit.  C Within 0/-20% of initial value.  Shall be satisfied the value on  "Standard list"  -  L: +105°C  Within +50/0% of initial value.  Shall be satisfied the value on	over 24h and then measure the sample.  As per 4.29 JIS C 5101-1
Temperature Stability  □ DF (tan L.C  Temp □ C  □ C  □ C  □ C  □ C  □ C  □ C  □ C	Shall be satisfied the value on  Standard list "  Standard list "  Standard list "  Shall be satisfied the value on " Standard list "  Shall be satisfied the value on " Standard list "	As per 4.29 JIS C 5101-1
Temperature Stability  □ DF (tan L.C  Temp □ C  □ C  □ C  □ C  □ C  □ C  □ C  □ C	Shall be satisfied the value on  Standard list "  Standard list "  Standard list "  Shall be satisfied the value on " Standard list "  Shall be satisfied the value on " Standard list "	
Temperature Stability  □ DF (tan □ L.C  □ Temp □ □ C  □ C  □ C  □ C  □ C  □ C  □ C  □	Shall be satisfied the value on Standard list " Standard list " Within +50/0% of initial value.	
Stability	Shall be satisfied the value on Standard list "  : +105°C  Within +50/0% of initial value.  Shall be satisfied the value on	
Dif (tan L.C Temp ⊿C Dif (tan L.C Surge App voltage	Shall be satisfied the value on "Standard list"	As per 4.13 JIS C 5101-3
Compared to the control of the cont	5) "Standard list "   .: +105°C  C Within +50/0% of initial value.  Shall be satisfied the value on	
Temp  △C  Dif  (tan  L.C  Surge  App  voltage	. : +105°C  C Within +50/0% of initial value.  Shall be satisfied the value on	
Temp ⊿C  Di (tan L.C  Surge App voltage aran	.: +105°C  C Within +50/0% of initial value.  Shall be satisfied the value on	
□ DF (tan  L.C  Surge App  voltage arar	C Within +50/0% of initial value.  Shall be satisfied the value on	
Di (tan L.C) Surge App voltage aran	Shall be satisfied the value on	
Surge App voltage aran		
Surge App voltage arar	5)  " Standard list "	
Surge App voltage arar	-,   Standard list	
voltage arar	. Less than 1000% of initial limit.	
	e- There should be no significant	As per 4.26JIS C 5101-1
L.C	ce abnormality.	As per 4.14JIS C 5101-3
L.C	The indications should be clear.	Apply the specified surge voltage via the serial
	. Less than 200% of initial limit.	resistance of $1k\Omega$ ever $5\pm0.5$ min. for $30\pm5$ s.
		each time in the atmospheric condition of
<b>⊿</b> C,	C Within ±20% of initial value.	85±2°C. Repeat this procedure 1,000 times.  After the specimens, leave it at room temperature
DF	Less than 200% of initial limit.	for over 24h and then measure the sample.
(tan		<u>'</u>
Loading at App	e- There should be no significant	As per 4.23 JIS C 5101-1
High arar		As per 4.15 JIS C 5101-3
temperature	The indications should be clear.	After applying the rated voltage for 1000+72/0 h
L.C	. Less than 400% of initial limit.	without discontinuation via the serial resistance
		of 3Ω or less at a temperature of 85±2°C, leave
⊿C	C Within ±20% of initial value.	the sample at room temperature / humidity for
DF	Less than 300% of initial limit.	over 24h and measure the value.
(tan	LL 622 HAU 2007/201 HHIM HIM	•

**TCTO** series A case

Item		Performance	Test conditions
Terminal	Capa	The measured value should be	(based on JIS C 5101-1 and JIS C 5101-3)
	Capa- citance	stable.	As per 4.35 JIS C 5101-1 As per 4.9 JIS C 5101-3
strength	Appe-		<del>-</del>
		There should be no significant	A force is applied to the terminal until it bends to
	arance	abnormality.	1mm and by a prescribed tool maintains the
			condition for 5s.
			(See the figure below)
Adhesiveness		The terminal should not come off.	As per 4.34 JIS C 5101-1 As per 4.8 JIS C 5101-3 Apply force of 2N in the true directions above in
			Apply force of 2N in the two directions shown in
			the figure below for 10±1s after mounting the
			terminal on a circuit board.
			Apply force A circuit board
Dimensions		Refer to "External dimensions".	Measure using a caliper of JIS B 7507 Class 2 or higher grade.
		1 -	
Resistance to		The indication should be clear.	As per 4.32 JIS C 5101-1
Resistance to solvents		The indication should be clear.	As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3
		The indication should be clear.	
		The indication should be clear.	As per 4.18 JIS C 5101-3
solvents		The indication should be clear.  3/4 or more surface area of the	As per 4.18 JIS C 5101-3  Dip in the isopropyl alcohol for 30±5s, at room temperature.
solvents		3/4 or more surface area of the	As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature. As per 4.15.2 JIS C 5101-1
solvents		3/4 or more surface area of the solder coated terminal dipped in	As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3
solvents		3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be	As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s
solvents		3/4 or more surface area of the solder coated terminal dipped in	As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging):
solvents		3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be	As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water
solvents		3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be	As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1h.
solvents		3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be	As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1h. Solder temp.: 245±5°C
		3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be	As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1h. Solder temp.: 245±5°C Duration: 3±0.5s
solvents		3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be	As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1h. Solder temp.: 245±5°C Duration: 3±0.5s Solder: M705
Solderability		3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be covered with the new solder.	As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1h. Solder temp.: 245±5°C Duration: 3±0.5s Solder: M705 Flux: Rosin 25% IPA 75%
Solderability	Сара-	3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be covered with the new solder.  Measure value should not fluctuate	As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1h. Solder temp.: 245±5°C Duration: 3±0.5s Solder: M705 Flux: Rosin 25% IPA 75% As per 4.17 JIS C 5101-1
Solderability	citance	3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be covered with the new solder.  Measure value should not fluctuate during the measurement.	As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1h. Solder temp.: 245±5°C Duration: 3±0.5s Solder: M705 Flux: Rosin 25% IPA 75% As per 4.17 JIS C 5101-1 Frequency: 10 to 55 to 10Hz/min.
Solderability		3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be covered with the new solder.  Measure value should not fluctuate during the measurement.  There should be no significant	As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1h. Solder temp.: 245±5°C Duration: 3±0.5s Solder: M705 Flux: Rosin 25% IPA 75% As per 4.17 JIS C 5101-1 Frequency: 10 to 55 to 10Hz/min. Amplitude: 1.5mm
Solderability	citance	3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be covered with the new solder.  Measure value should not fluctuate during the measurement.	As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1h. Solder temp.: 245±5°C Duration: 3±0.5s Solder: M705 Flux: Rosin 25% IPA 75% As per 4.17 JIS C 5101-1 Frequency: 10 to 55 to 10Hz/min.
solvents	citance Appe-	3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be covered with the new solder.  Measure value should not fluctuate during the measurement.  There should be no significant	As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1h. Solder temp.: 245±5°C Duration: 3±0.5s Solder: M705 Flux: Rosin 25% IPA 75% As per 4.17 JIS C 5101-1 Frequency: 10 to 55 to 10Hz/min. Amplitude: 1.5mm



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# Standard products list

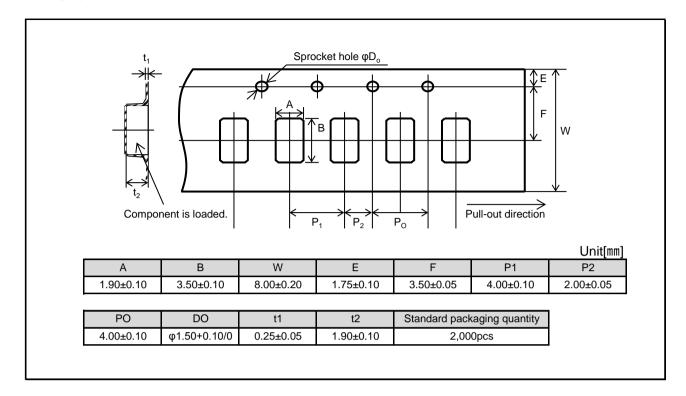
	Rated	Category	Surge	Cap.	Tole-	Leakage		tanδ		ESR	Max
	voltage	voltage	voltage		rance	current		120Hz			allowable
	85°C	105°C	85°C	120Hz		25℃				100kHz	ripple
Part No.						1WV	-55℃	25℃	105℃		current
						5min					≦45°C
											100kHz
	(V)	(V)	(V)	(µF)	(%)	(µA)	(%)	(%)	(%)	$(m\Omega)$	(mArms)
TCTOA0E227M8R-ZN1	2.5	2	3.2	220	±20	55.0	15	15	20	35	1,500
* TCTOA0E337M8R-ZN1	2.5	2	3.2	330	±20	82.5	15	15	20	35	1,414
* TCTOA0E337M8R-ZD1	2.5	2	3.2	330	±20	82.5	15	15	20	200	592
* TCTOA0J107M8R-ZN1	6.3	5	8	100	±20	63.0	15	15	20	35	1,600
TCTOA0J107M8R-ZS1	6.3	5	8	100	±20	63.0	15	15	20	45	1,500
* TCTOA0J157M8R-ZN1	6.3	5	8	150	±20	94.5	15	15	20	35	1,414
TCTOA0J157M8R	6.3	5	8	150	±20	94.5	15	15	20	200	592
TCTOA1A476M8R	10	8	13	47	±20	47.0	10	10	15	200	592
TCTOA1C226M8R-ZD1	16	12.8	20	22	±20	35.2	10	10	15	200	592
* TCTOA1E106M8R-ZD1	25	20	29	10	±20	75.0	10	10	15	200	592

<sup>\*</sup> This specification has possibility of charge, due to underdevelopment product. Please ask for latest specification to our sales.

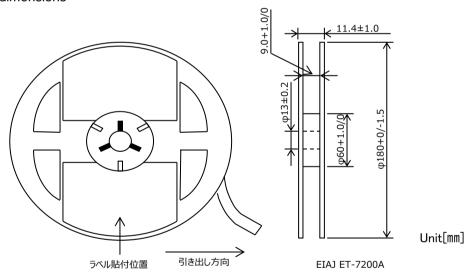


TCTO series A case Datasheet

#### Packaging specifications



#### Reel dimensions

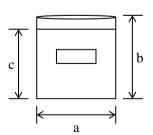


## Damp proof package

- 1)One reel is packed in aluminum bag.
  - The size of aluminum bag is 240(a) x 250(b)mm.

The size up to 230(c)mm is to zipper.

- ②A desiccant is packed with a reel.
- 3The aluminum bag is heat-sealed.
- 4)The label of the same as the label on the reel is placed on the aluminum bag.



# **Notice**

#### **Precaution on using ROHM Products**

1. Our Products are designed and manufactured for application in ordinary electronic equipment (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASSⅢ	CL ACCIII	CLASS II b	СГУССШ
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSIII

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
  - [a] Installation of protection circuits or other protective devices to improve system safety
  - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
- 3. Our Products are designed and manufactured for use under standard conditions and not under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
  - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### **Precautions Regarding Application Examples and External Circuits**

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

#### **Precaution for Product Label**

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

#### **Precaution for Disposition**

When disposing Products please dispose them properly using an authorized industry waste company.

#### **Precaution for Foreign Exchange and Foreign Trade act**

Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

#### **Precaution Regarding Intellectual Property Rights**

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- 4. The proper names of companies or products described in this document are trademarks or registered trademarks of ROHM, its affiliated companies or third parties.

#### **General Precaution**

- 1. Before you use our Products, you are requested to care fully read this document and fully understand its contents. ROHM shall not be in any way responsible or liable for failure, malfunction or accident arising from the use of a ny ROHM's Products against warning, caution or note contained in this document.
- 2. All information contained in this docume nt is current as of the issuing date and subject to change without any prior notice. Before purchasing or using ROHM's Products, please confirm the latest information with a ROHM sale s representative.
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